

Features

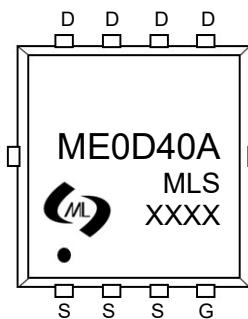
- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

Product Summary

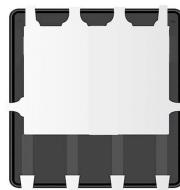
V _{DS}	R _{DS(ON)} MAX	I _D MAX
30V	8mΩ@10V	40A
	13mΩ@4.5V	

Application

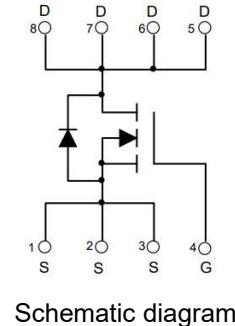
- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch



ME0D40A: Device code
XXXX:Code



PDFN3X3-8L view



Schematic diagram

Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V _{DS}	Drain-Source Breakdown Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _c =25°C 40	A
Mounted on Large Heat Sink			
I _{DM}	Pulse Drain Current Tested	T _c =25°C 160	A
I _D	Continuous Drain Current	T _c =25°C 40	A
P _D	Maximum Power Dissipation	T _c =25°C 25	W
R _{θJA}	Thermal Resistance Junction-Ambient	75	°C/W
E _{AS}	Single pulse avalanche energy ^{Note1}	51.5	mJ

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
ME0D40A	PDFN3X3-8L	ME0D40A	5,000	10,000	70,000	13" reel

Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =15A	--	6	8	mΩ
		V _{GS} =4.5V, I _D =10A	--	9	13	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	--	1015	--	pF
C _{OSS}	Output Capacitance		--	201	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	164	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =20V, I _D =20A, V _{GS} =10V	--	23.6	--	nC
Q _{gs}	Gate Source Charge		--	3.9	--	nC
Q _{gd}	Gate Drain Charge		--	7	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =20V, R _G =3Ω, V _{GS} =10V	--	7	--	nS
t _r	Turn-on Rise Time		--	19	--	nS
t _{d(off)}	Turn-Off Delay Time		--	24	--	nS
t _f	Turn-Off Fall Time		--	24	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _j =25°C, I _S =20A	--	--	1.2	V

Note :

1、EAS Test condition : V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_D=23A, R_G=25Ω, Starting T_j=25° C.

Typical Operating Characteristics

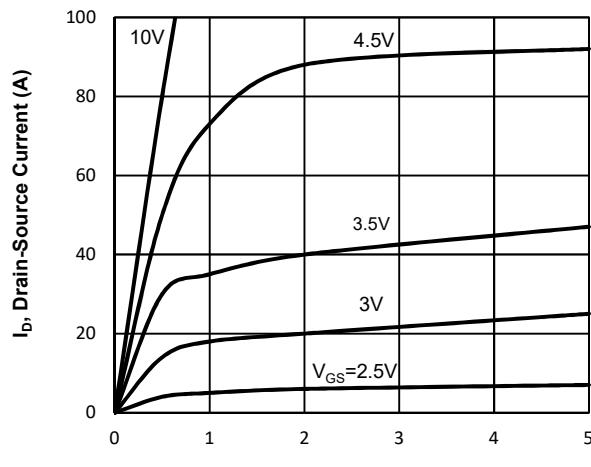


Fig1. Typical Output Characteristics

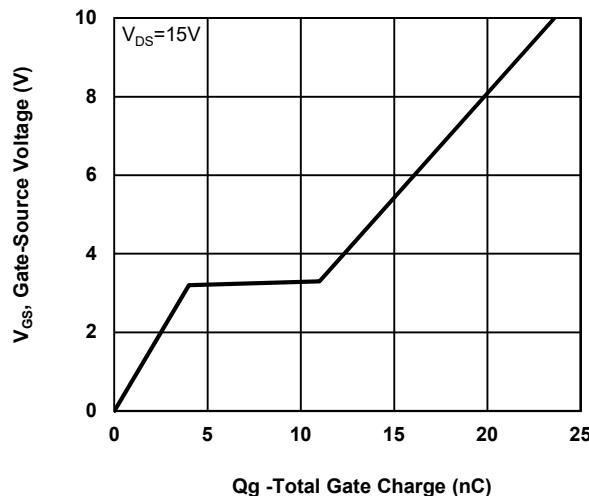


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

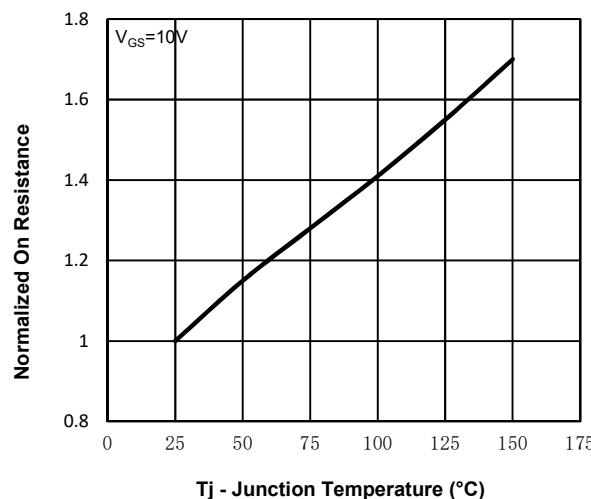


Fig3. Normalized On-Resistance Vs. Temperature

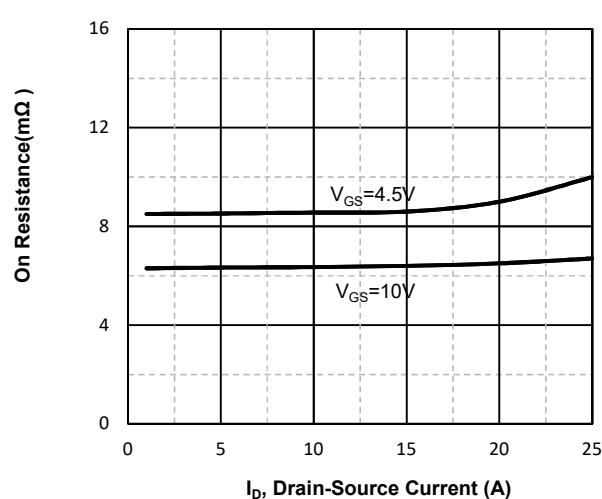


Fig4. On-Resistance Vs. Drain-Source Current

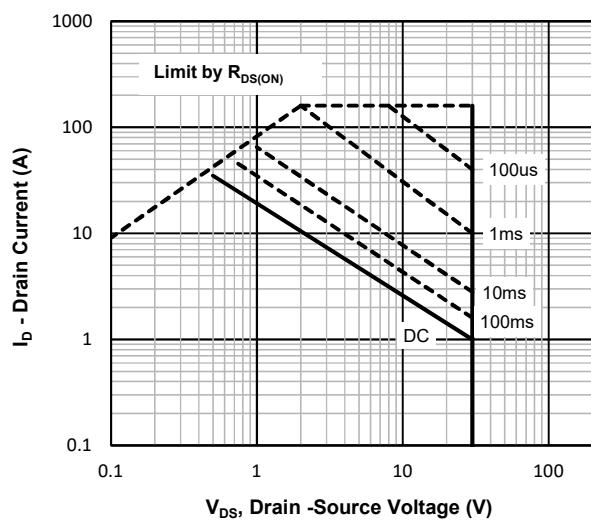


Fig5. Maximum Safe Operating Area

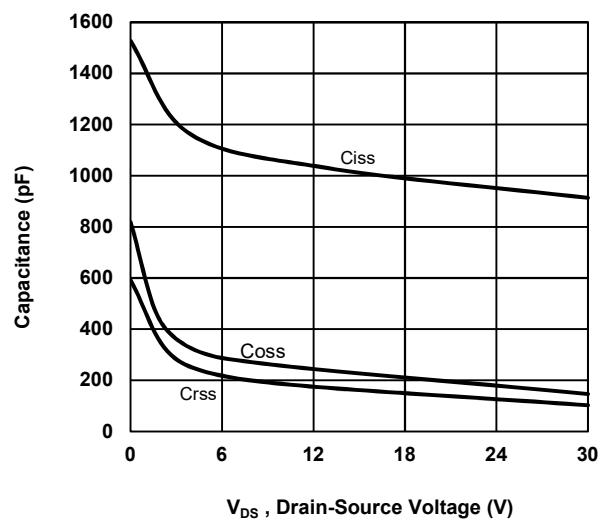
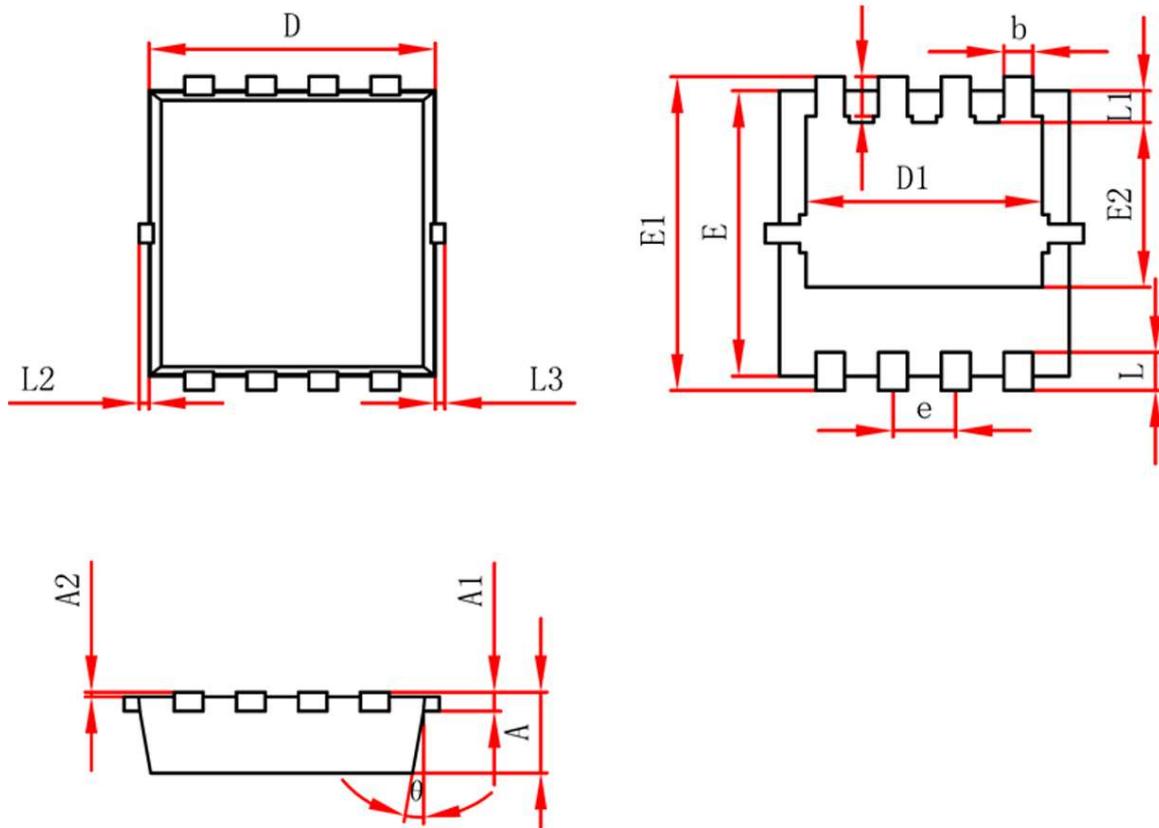


Fig6. Typical Capacitance Vs. Drain-Source Voltage

PDFN3X3-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.750	0.850	0.030	0.034
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.950	3.150	0.117	0.125
D1	2.400	2.500	0.095	0.099
E	2.950	3.050	0.117	0.121
E1	3.250	3.350	0.129	0.132
E2	1.685	1.785	0.067	0.071
b	0.250	0.350	0.010	0.014
e	0.600	0.700	0.024	0.028
L	0.350	0.450	0.014	0.018
L1	0.325	0.425	0.013	0.017
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.365	0.465	0.014	0.018
θ	10°	12°	10°	12°